

## N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTOR

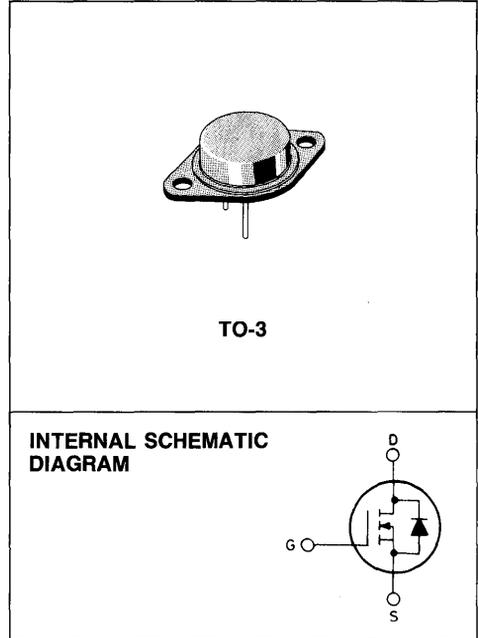
TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
SGSP577	200 V	0.17 Ω	20 A

- HIGH SPEED SWITCHING APPLICATIONS
- HIGH CURRENT - FOR TELECOMM POWER SUPPLIES
- ULTRA FAST SWITCHING
- EASY DRIVE FOR REDUCED COST AND SIZE

**INDUSTRIAL APPLICATIONS:**

- SWITCHING MODE POWER SUPPLIES
- MOTOR CONTROLS FOR ROBOTICS.

N - channel enhancement mode POWER MOS field effect transistor. Easy drive and very fast switching times make this POWER MOS transistor ideal for high speed switching applications. Typical applications include robotics, UPS, SMPS and DC/DC converters, electric vehicle drives and a DC switch for telecommunications.


**ABSOLUTE MAXIMUM RATINGS**

V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	200	V
V <sub>DGR</sub>	Drain-gate voltage (R <sub>GS</sub> = 20 KΩ)	200	V
V <sub>GS</sub>	Gate-source voltage	±20	V
I <sub>D</sub>	Drain current (cont.) at T <sub>c</sub> = 25°C	20	A
I <sub>D</sub>	Drain current (cont.) at T <sub>c</sub> = 100°C	13	A
I <sub>DM</sub> (*)	Drain current (pulsed)	80	A
I <sub>DLM</sub> (*)	Drain inductive current, clamped	80	A
P <sub>tot</sub>	Total dissipation at T <sub>c</sub> < 25°C	150	W
	Derating factor	1.2	W/°C
T <sub>stg</sub>	Storage temperature	-65 to 150	°C
T <sub>j</sub>	Max. operating junction temperature	150	°C

(\*) Pulse width limited by safe operating area

**THERMAL DATA**

$R_{th(j) - case}$	Thermal resistance junction-case	max	0.83	°C/W
$T_L$	Maximum lead temperature for soldering purpose		275	°C

**ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25^{\circ}C$  unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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**OFF**

$V_{(BR) DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu A$ $V_{GS} = 0$	200			V
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$ $T_c = 125^{\circ}C$			250 1000	$\mu A$ $\mu A$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20 V$			$\pm 100$	nA

**ON (\*)**

$V_{GS (th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ $I_D = 250 \mu A$	2		4	V
$R_{DS (on)}$	Static drain-source on resistance	$V_{GS} = 10 V$ $I_D = 10 A$ $V_{GS} = 10 V$ $I_D = 10 A$ $T_c = 100^{\circ}C$			0.17 0.34	$\Omega$ $\Omega$

**DYNAMIC**

$g_{fs}$	Forward transconductance	$V_{DS} = 25 V$ $I_D = 10 A$	8			mho
$C_{iss}$	Input capacitance			1900	2200	pF
$C_{oss}$	Output capacitance	$V_{DS} = 25 V$ $V_{GS} = 0$			550	pF
$C_{rss}$	Reverse transfer capacitance	$f = 1 \text{ MHz}$			260	pF

**SWITCHING**

$t_{d (on)}$	Turn-on time	$V_{DD} = 100 V$ $V_i = 10 V$	$I_D = 10 A$ $R_i = 4.7 \Omega$		30	40	ns
$t_r$	Rise time				50	65	ns
$t_{d (off)}$	Turn-off delay time	(see test circuit)			110	145	ns
$t_f$	Fall time				35	45	ns

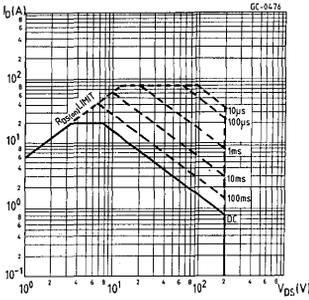
ELECTRICAL CHARACTERISTICS (Continued)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
$I_{SD}$ $I_{SDM}$ (*)	Source-drain current Source-drain current (pulsed)			20 80	A A
$V_{SD}$	Forward on voltage	$I_{SD} = 20\text{ A}$	$V_{GS} = 0$	1.3	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 20\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$	$V_{GS} = 0$	320	ns

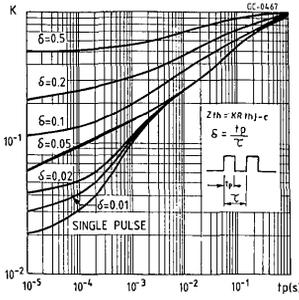
(\*) Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

(\*) Pulse width limited by safe operating area

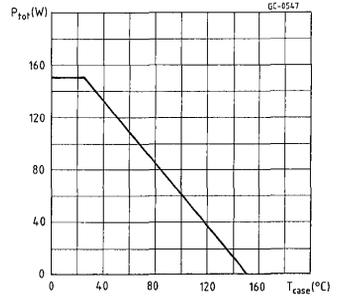
Safe operating areas



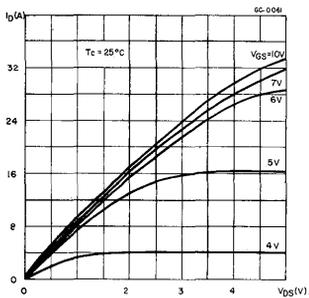
Thermal impedance



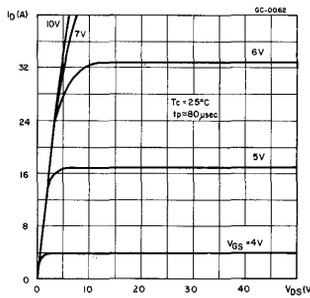
Derating curve



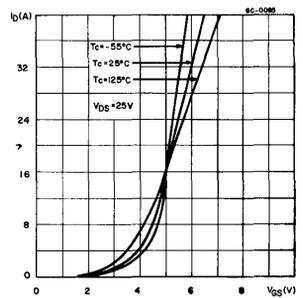
Output characteristics



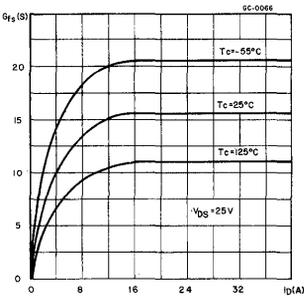
Output characteristics



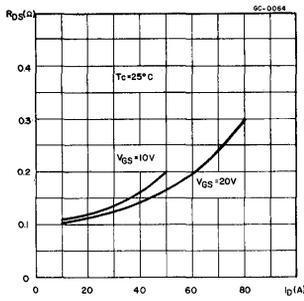
Transfer characteristics



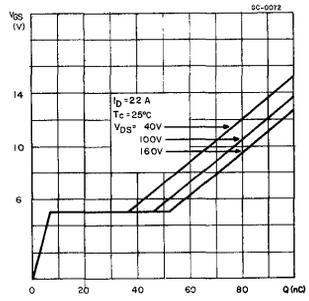
Transconductance



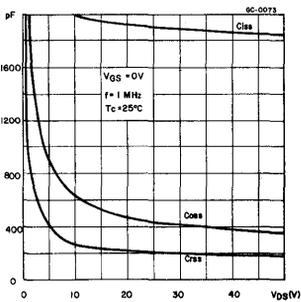
Static drain-source on resistance



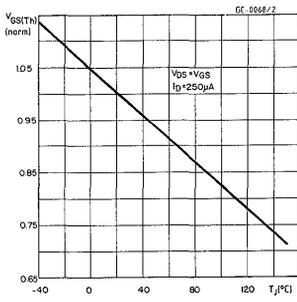
Gate charge vs gate-source voltage



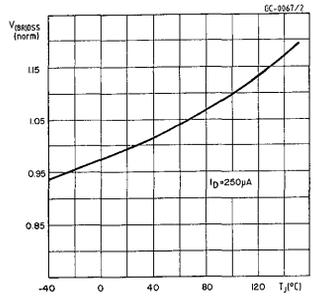
Capacitance variation



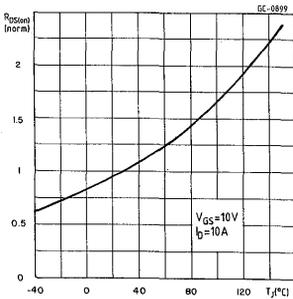
Normalized gate threshold voltage vs temperature



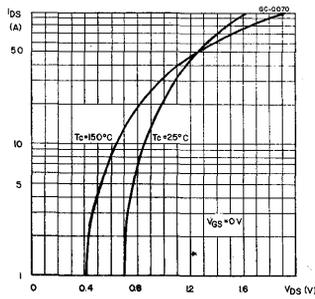
Normalized breakdown voltage vs temperature



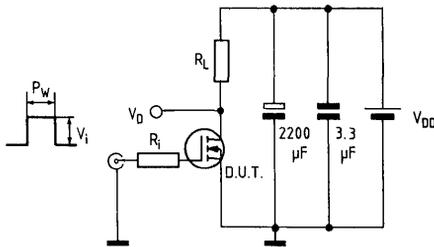
Normalized on resistance vs temperature



Source-drain diode forward characteristics



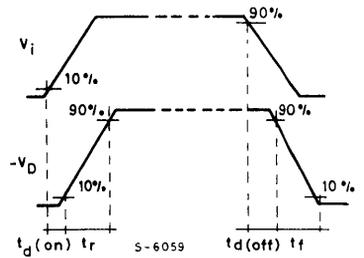
Switching times test circuit for resistive load



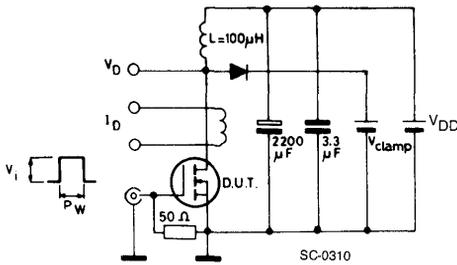
Pulse width  $\leq 100 \mu\text{s}$   
 Duty cycle  $\leq 2\%$   
 $V_i = 10 \text{ V}$

SC-0008/1

Switching time waveforms for resistive load



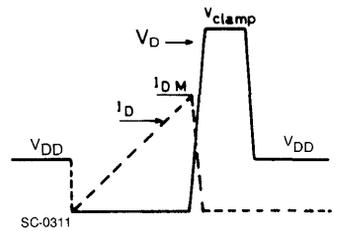
Clamped inductive load test circuit



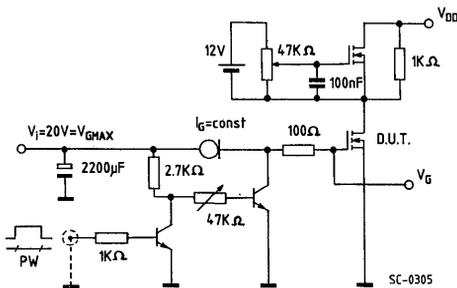
$V_i = 12 \text{ V}$  - Pulse width: adjusted to obtain specified  $I_{DM}$ ,  $V_{\text{clamp}} = 0.75 V_{(BR) \text{ DSS}}$

SC-0310

Clamped inductive waveforms



Gate charge test circuit



PW adjusted to obtain required  $V_G$

SC-0305

Body-drain diode  $t_{rr}$  measurement  
 Jedec test circuit

